

Form Type	Distribute	Version	2.0	Ref		IPC 1752A		Sectionals	Material Info		Subsectionals	D, A
Supplier Information												
Company Name	E TE Connectivi	ky Request Document I	D	(Contact Name		Wu, Cc		Contact Title Er		igineer Product C	ompliance china
Company Unique ID	TE Connectivi	ky Response I	Date 2018-03-1	5 0	Contact	Email	cc.wu	@te.com				
Contact Phone Number 86-2124071672												
	_			I	Legal St	atement						
Supplier true Acceptance												
Legal Statemen	t											
											is information doe d companies) and	
Product												
Manufacturer Item number	1-282045-3	Amount	4472.453	ľ	Version		-		Identity			
Manufacturer Item Name	AMP MONO- SHAPE PCB CONN	Weight Uon	n mg	lmg M		Mfr Site			Authority			
Date		UOM	Each			.						
EURoHS-0508	Product(s) meets EU RoHS requirement without any exemptions											
ChinaRoHS- 0508	Product(s) is eligible for marking with the e code under China's Measures for Administration of the control of pollution by Electronic Information Products											
EUREACH-0117	REACH Candi											
Complex Article Description	e REACH Candi	date Substances	s of Very High Co	ncern aco	cording t	to Once ar	n Article	e Always an	Article are Not	Yet Re	eviewed	
				Pr	oduct D	isclosure	•					1
Sub- Item/Material/ Substance	Level	Name	Substance Category	Substar CAS	nce	Substance Concentratio		Quantity	Mass pe	r Unit	UOM	Exemption
Sub-Item	1	MONO SHAPE MKI CONTACT FOLDED						5.0	352.4		mg	
Material	2	Brass						5.0	350.0		mg	
Substance	3	Chromium	Supplier	er 7440-47		0.0010		5.0	0.0035		mg	
Substance	3	Zinc	Supplier	7440-66		28.0225		5.0	98.07875	5	mg	
Substance	3	Manganese	Supplier	7439-96-		0.05		5.0	0.175		mg	
Substance	3	Antimony	Supplier	7440-36-0		0.01		5.0	0.035		mg	
Substance	3	Iron	Supplier	7439-89-6		0.05		5.0	0.175		mg	
Substance	3	Cobalt	Supplier	7440-48-4		0.1		5.0	0.35		mg	
Substance	3	Copper	Supplier	7440-50-8		71.5		5.0	250.25		mg	
Substance	3	Beryllium	Supplier	7440-41-7		0.0010		5.0	0.0035		mg	
Substance Substance	3 3	Arsenic Mercury	Supplier Mercury/Mercu	7440-38-2 7439-97-6		0.01 5.0E-4		5.0 5.0	0.035		mg mg	
	-		ry Compounds									
Substance Substance	3 3	Nickel Cadmium	Nickel Cadmium/Cad	7440-02 7440-43		0.2		5.0 5.0	0.7		mg mg	
			mium Compounds									
Substance	3	Lead	Lead/Lead Compounds	7439-92-1		0.05		5.0	0.175		mg	
Material	2	Tin Plate		 			5.0		2.4		mg	
Substance	3	Tin	Supplier	7440-31-5		99.73		5.0	2.39352		mg	
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081 1212	-2-	0.2		5.0	0.0048		mg	
Substance	3	Lead	Lead/Lead Compounds	7439-92	!-1	0.07		5.0	0.00168		mg	
Sub-Item	1	AMP MONO- SHAPE PCB HSG						1.0	2710.453	3	mg	
Material	2	PA66-GF20- FR(16+72)						1.0	2710.453	3	mg	
Substance	3	Boric acid, zinc salt	Supplier	1332-07-6		8.0		1.0	216.8362	24	mg	

Substance	3	Poly[imino(1,6- dioxo-1,6- hexanediyl)imi no-1,6- hexanediyl]	Supplier	32131-17-2	45.0	1.0	1219.70385	mg	
Substance	3	Benzene, ethenyl-, homopolymer, brominated	Supplier	88497-56-7	20.0	1.0	542.0906	mg	
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2- 1212	5.0	1.0	135.52265	mg	
Substance	3	Glass, oxide, chemicals	Supplier	65997-17-3	22.0	1.0	596.29966	mg	